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|----------------------|------------------|
| Applications | Automotive Grade |
| Feature | AEC-Q200 |
| | Multilayer |
| | Magnetic Shield |
| | Ferrite Core |
| Series Type | MLF |
| Status | Production |
| Brand | TDK |



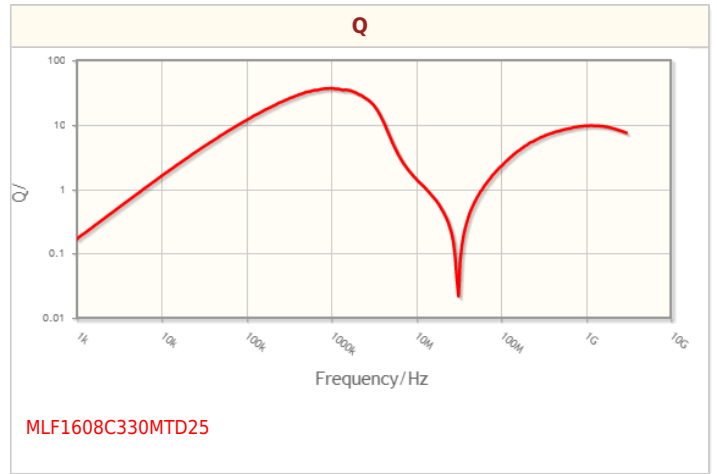
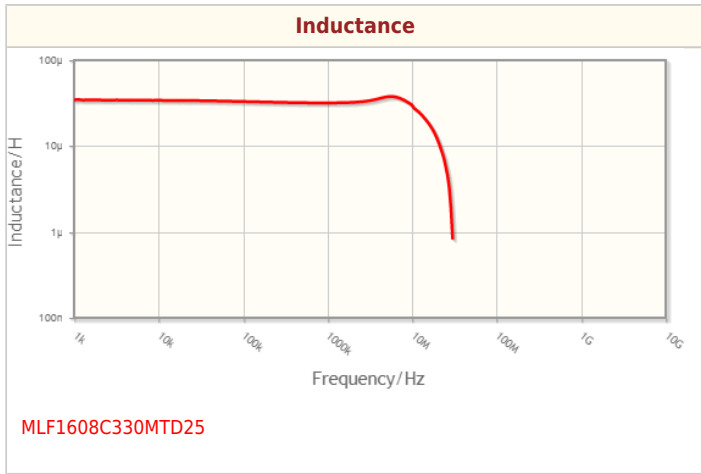
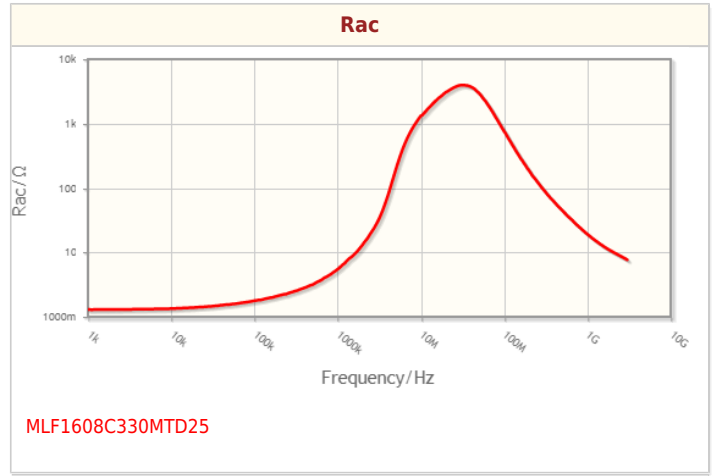
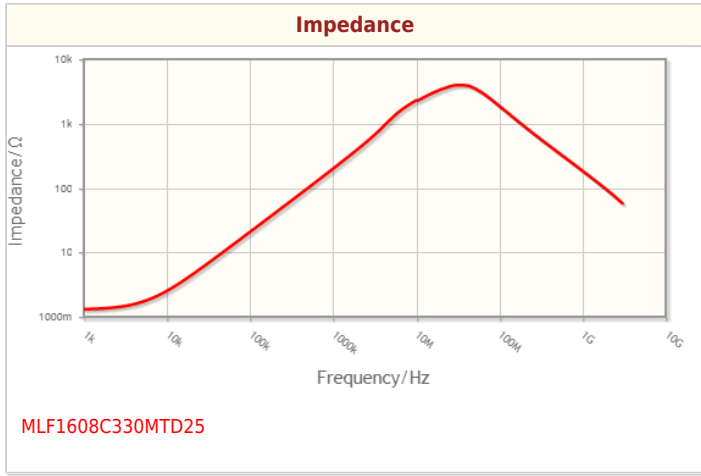
| Size | |
|------------------------------|----------------|
| Length(L) | 1.60mm ±0.15mm |
| Width(W) | 0.80mm ±0.15mm |
| Thickness Height | 0.80mm ±0.15mm |
| Recommended Land Pattern (A) | 0.60mm Nom. |
| Recommended Land Pattern (B) | 0.80mm Nom. |
| Recommended Land Pattern (C) | 0.80mm Nom. |

| Electrical Characteristics | |
|---|-------------------|
| Inductance | 33µH ±20% at 1MHz |
| Rated Current (L Change) [Typ.] | |
| Rated Current (L Change) [Max.] | 2mA |
| Rated Current (Temperature Rise) [Typ.] | |
| Rated Current (Temperature Rise) [Max.] | |
| DC Resistance [Typ.] | 1.4Ω |
| DC Resistance [Max.] | 2.2Ω |
| Self Resonant Frequency [Min.] | 10MHz |
| Self Resonant Frequency [Typ.] | 30MHz |
| Q [Min.] | 20 at 1MHz |
| Q [Typ.] | 40 at 1MHz |

| Other | |
|---|------------------------------------|
| Operating Temp. Range (Including Self-Temp. Rise) | -40 to 85°C |
| Soldering Method | Reflow |
| | Iron Soldering |
| AEC-Q200 | YES |
| Packing | Punched (Paper)Taping [180mm Reel] |
| Package Quantity | 4000pcs |
| Weight | 0.004g |

! Images are for reference only and show exemplary products.
! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.

Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



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Associated Images

